<u>KARMA STRAIN GAGES</u> TEE ROSETTE GAGES

- K-Series, Transducers Quality
- Good Linearity Over Wide Temperature Range -75 to 200°C (-100 to 392°F) For Equations
- Good Fatigue Life
- Custom Gages Available—Fast Delivery

OMEGA® offers K-Series Tee Rosettes for Axial strain transducer designs.

Three different Tee Rosette styles available:

SGK-B3A-K350U -***** has 2 separate strain gages with perpendicular grids on a single carrier.

SGK-BH3A-K350U-***** is a half-bridge design, with 2 strain gages, perpendicular grids with a common lead/pad on a single carrier.

SGK-B5A-K350W-***** is a half-bridge Tee Rosette design, often used for column load cell design where high accuracy is a requirement. The geometry for this strain gage is shown with the tabs along the top, and the center strain gage is vertical, and used for the principal stress direction in the column. The Perpendicular grid is split, half on each side. This may also be known as transverse grid. The transverse grid tends to correct for bending strain, or off-axis loading in the column.





**** PC11 or PC23

Visit us online

To Order									
GAGE			DIM	DIMENSIONS mm (inch) [†]					
Shown		NOM. RESIS-	GRID		CARRIER				
actual size Leads not shown	MODEL NO. Pkg of 5	TANCE (Ω)	А	В	С	D	MAX V* (Vrms)	TERMINATION	TEMP COMP
7.5 mm ↑ III II	SGK-B3A-K350U-PC11-E	350	3.2 (0.126)	4.0 (0.157)	7.5 (0.3)	10.8 (0.43)	12.5	Solder Pads	ST
	SGK-B3A-K350U-PC23-E	350	90° TEE rosette axial strain, separate gages 350 Ω			n,	17.5	Solder Pads	AL
7.5 mm	SGK-BH3A-K350U-PC11-E	350	3.2 (0.126)	4.0 (0.157)	7.5 (0.3)	10.8 (0.43)	12.5	Solder Pads	ST
	SGK-BH3A-K350U-PC23-E	350	90 C	° TEE rosett ommon lead	e half-bridg I/pad 350 Ω	e,	17.5	Solder Pads	AL
9.8 mm	SGK-B5A-K350W-PC11-E	350	5.0 (0.197)	2.3 (0.091)	9.8 (0.39)	9.0 (0.35)	11	Solder Pads	ST
	SGK-B5A-K350W-PC23-E	350	C	Used for hig olumn load	h accuracy cells 350 Ω		15	Solder Pads	AL

* Maximum permitted bridge energizing voltage (Vrms). Note: For strain gage accessories visit us online.

Ordering Example: SGK-BH3A-K350U-PC11-E, package of 5, Tee rosette for axial strain, half-bridge with a common solder pad, nominal resistance 350 Ω .

BONDABLE TERMINAL PADS

When installing strain gages with ribbon leads or solder pads, use Bondable Terminal Pads (BTP) between the strain gage and the wires to your instrumentation.

The Bondable Terminal Pads provide a large easy to use soldering area and provide strain relief between the strain gage and the heavy instrument wires.

Using Bondable Terminal Pads is simple. Use the same adhesive and bonding procedure on the Bondable Terminal Pads as you use on the strain gage.

OMEGA offers BTPs in several sizes and wiring configurations to fit most all strain gage applications.

DISCOUNT SCHEDULE
to 10 pkgs Net
1 to 24 pkgs
25 to 49 pkgs10%
50 and up and OEMConsult Factory





